

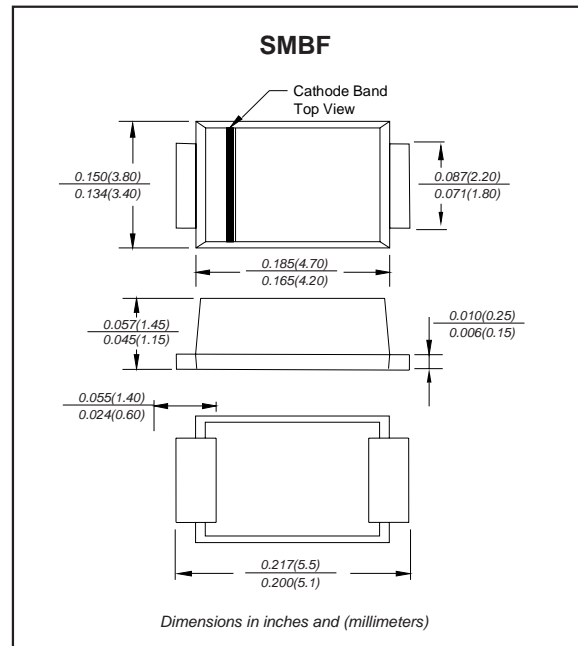
Features

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ For surface mounted applications
- ◆ Low reverse leakage
- ◆ Built-in strain relief, ideal for automated placement
- ◆ High forward surge current capability
- ◆ High temperature soldering guaranteed: 250°C/10 seconds at terminals
- ◆ Glass passivated chip junction
- ◆ Compliant to RoHS Directive 2011/65/EU
- ◆ Compliant to Halogen-free
- ◆ Suffix "-Q1" for AEC-Q101

Mechanical data

- ◆ **Case:** JEDEC SMBF molded plastic body
- ◆ **Terminals:** Solder plated, solderable per MIL-STD-750, Method 2026
- ◆ **Polarity:** Color band denotes cathode end
- ◆ **Mounting Position:** Any

Package outline



Maximum ratings and Electrical Characteristics (AT $T_A=25^\circ\text{C}$ unless otherwise noted)

PARAMETER	CONDITIONS	Symbol	MIN.	TYP.	MAX.	UNIT
Forward rectified current	See Fig.1	I_O			5.0	A
Forward surge current	8.3ms single half sine-wave (JEDEC method)	I_{FSM}			150	A
Reverse current	$V_R = V_{RRM}$ $T_A = 25^\circ\text{C}$	I_R			5.0	μA
	$V_R = V_{RRM}$ $T_A = 100^\circ\text{C}$				50	
Thermal resistance	Junction to ambient NOTE 1	$R_{\theta JA}$		40		$^\circ\text{C/W}$
Diode junction capacitance	f=1MHz and applied 4V DC reverse voltage	C_J		45		pF
Storage temperature		T_{STG}	-65		+150	$^\circ\text{C}$

Note: 1.P.C.B. mounted with 0.2x0.2" (5.0x5.0mm) copper pad areas

SYMBOLS	V_{RRM}^{*1} (V)	V_{RMS}^{*2} (V)	V_R^{*3} (V)	V_F^{*4} (V)	Operating temperature $T_{J,}$ ($^\circ\text{C}$)
S5A-BF-Q1	50	35	50	1.10	-55 to +150
S5B-BF-Q1	100	70	100		
S5D-BF-Q1	200	140	200		
S5G-BF-Q1	400	280	400		
S5J-BF-Q1	600	420	600		
S5K-BF-Q1	800	560	800		
S5M-BF-Q1	1000	700	1000		

Note: 1.P.C.B. mounted with 2.0x2.0" (5.0x5.0cm) copper pad areas

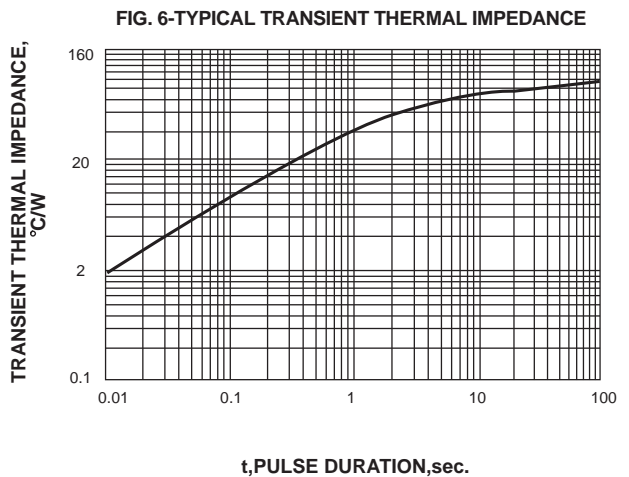
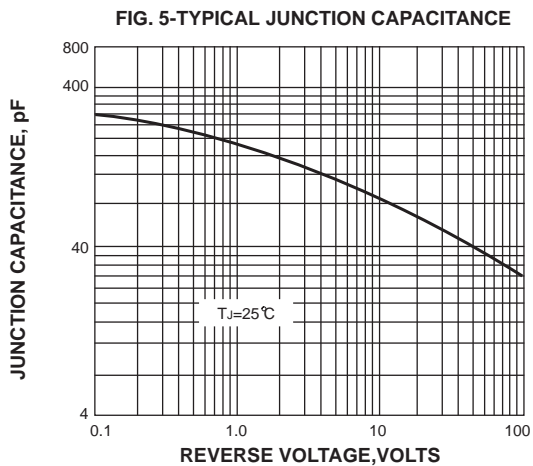
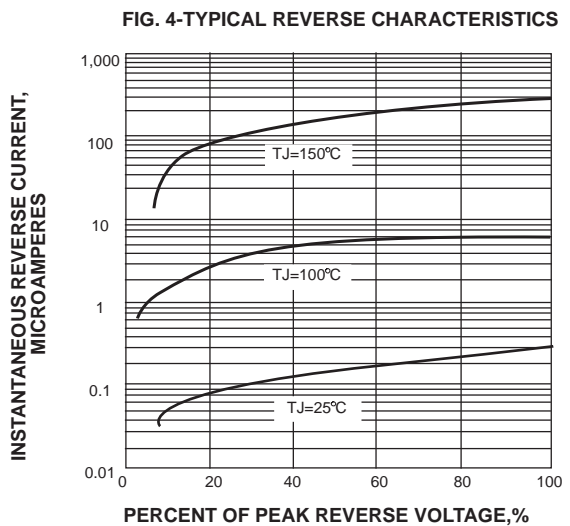
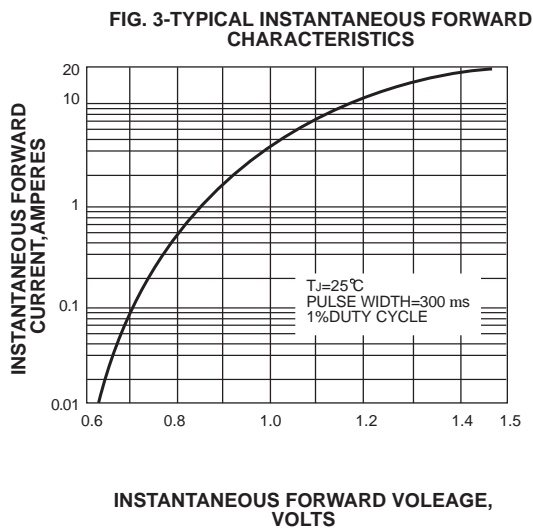
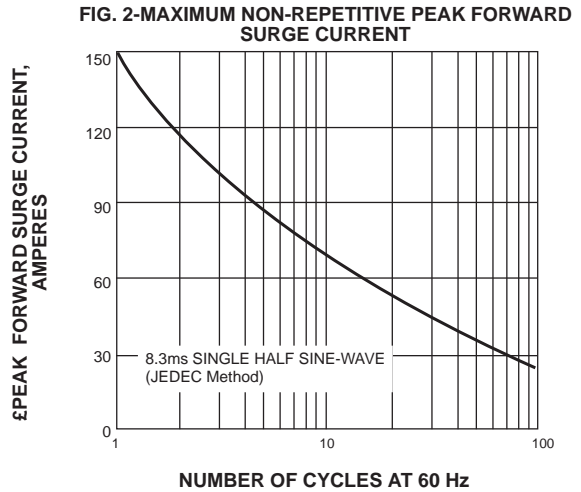
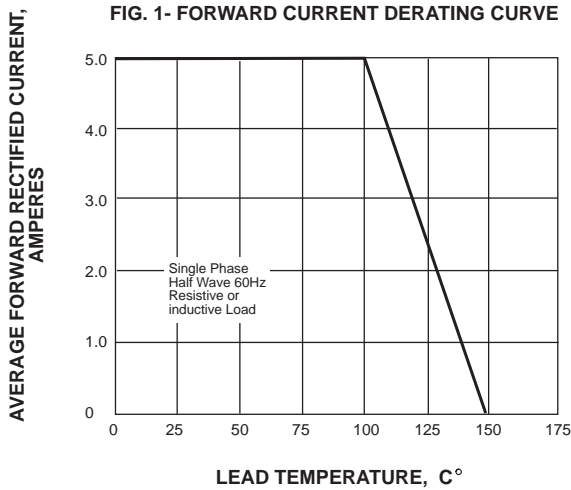
*1 Repetitive peak reverse voltage

*2 RMS voltage

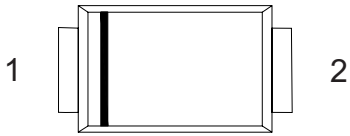

*3 Continuous reverse voltage

*4 Maximum forward voltage@ $I_F=5.0\text{A}$

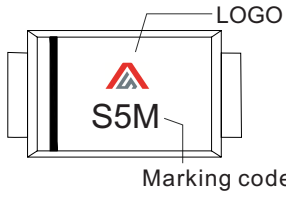
Rating and characteristic curves



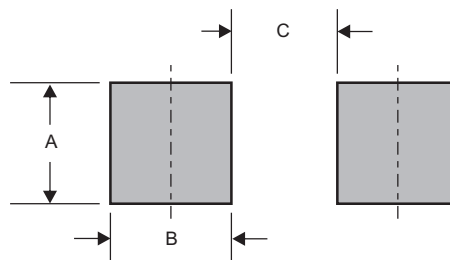
Pinning information

Pin	Simplified outline	Symbol
Pin1 cathode Pin2 anode		

Marking

Type number	Marking code	Example
S5A-BF-Q1	S5A	
S5B-BF-Q1	S5B	
S5D-BF-Q1	S5D	
S5G-BF-Q1	S5G	
S5J-BF-Q1	S5J	
S5K-BF-Q1	S5K	
S5M-BF-Q1	S5M	

Suggested solder pad layout



Dimensions in inches and (millimeters)

PACKAGE	A	B	C
SMBF	0.098 (2.50)	0.071 (1.80)	0.118 (3.00)